imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Dual Switching Diode Common Cathode

The BAV70M3T5G device is a spin-off of our popular SOT-23 three-leaded device. It is designed for switching applications and is housed in the SOT-723 surface mount package. This device is ideal for low-power surface mount applications where board space is at a premium.

Features

- Reduces Board Space
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	100	Vdc
Forward Current	١ _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Dissipation FR–5 Board (Note 1) T _A = 25°C Derate above 25°C	PD	265 2.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	470	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	P _D	640 5.1	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	195	°C/W
Junction and Storage Temperature	T _J , T _{stg}	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.

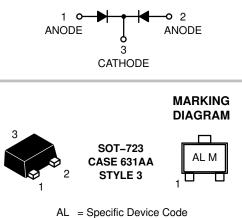
2. Alumina = 0.4 \times 0.3 \times 0.024 in. 99.5% alumina.



ON Semiconductor®

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70 V DUAL COMMON CATHODE SWITCHING DIODES



AL = Specific Device Co M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
BAV70M3T5G	SOT-723 (Pb-Free)	8000/Tape & Reel

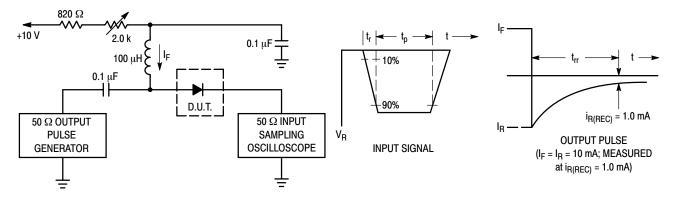
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BAV70M3

ELECTRICAL CHARACTERISTICS (T _A = 25°C unless otherwise note	d) (Each Diode)
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Characteristic		Symbol	Min	Max	Unit
Reverse Breakdown Voltage	(I _(BR) = 100 μA)	V _(BR)	100	-	V
Reverse Voltage Leakage Current (Note 3)	$(V_{R} = 25 \text{ V}, T_{J} = 150^{\circ}\text{C})$ $(V_{R} = 100 \text{ V})$ $(V_{R} = 70 \text{ V}, T_{J} = 150^{\circ}\text{C})$	I _R	- - -	60 1.0 100	μΑ
Diode Capacitance	(V _R = 0 V, f = 1.0 MHz)	CD	-	1.5	pF
Forward Voltage	$(I_F = 1.0 \text{ mA})$ $(I_F = 10 \text{ mA})$ $(I_F = 50 \text{ mA})$ $(I_F = 150 \text{ mA})$	VF	- - - -	715 855 1000 1250	mV
Reverse Recovery Time $(I_F = I_R = 10 \text{ mA}, I_{R(REC)} = 1.0 \text{ mA})$ (Figure 1)	R _L = 100 Ω	t _{rr}	-	6.0	ns

3. For each individual diode while second diode is unbiased.

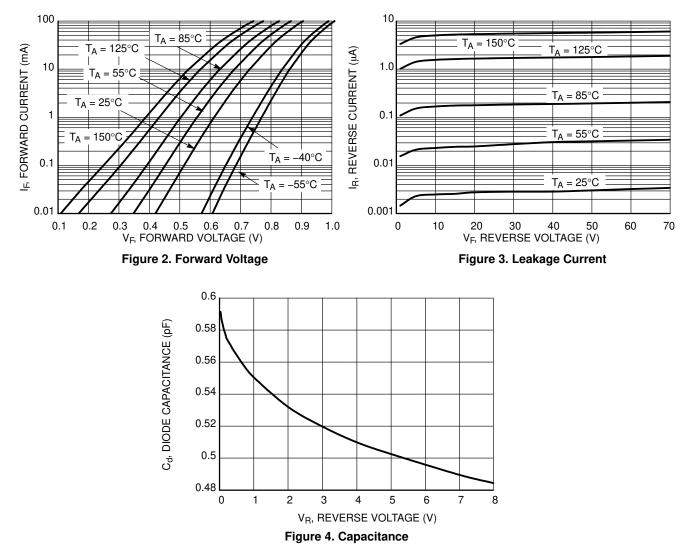


Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so $I_{R(peak)}$ is equal to 10 mA. 3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

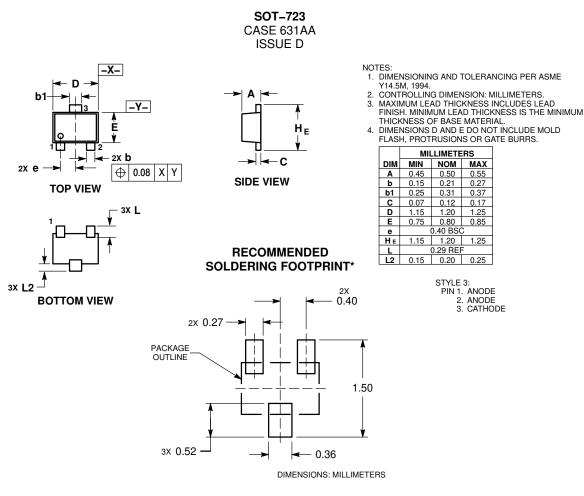
BAV70M3

Curves Applicable to Each Anode



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PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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